

Docket No. 248168US90CONT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF: Yasutaka ITO, et al.

SERIAL NO: NEW APPLICATION

FILED: HEREWITH

FOR: CERAMIC HEATER

INFORMATION DISCLOSURE STATEMENT UNDER 37 CFR 1.97

COMMISSIONER FOR PATENTS
ALEXANDRIA, VIRGINIA 22313

SIR:

Applicant(s) wish to disclose the following information.

REFERENCES

- ☒ The applicant(s) wish to make of record the references listed on the attached form PTO-1449. Copies of the listed references are attached, where required, as are either statements of relevancy or any readily available English translations of pertinent portions of any non-English language references.
- ☐ A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

RELATED CASES

- ☒ Attached is a list of applicant's pending application(s) or issued patent(s) which may be related to the present application. A copy of the patent(s), together with a copy of the claims and drawings of the pending application(s) is attached along with PTO 1449.
- ☐ A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

CERTIFICATION

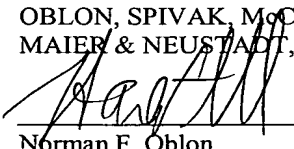
- ☐ Each item of information contained in this information disclosure statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this statement.
- ☐ No item of information contained in this information disclosure statement was cited in a communication from a foreign patent office in a counterpart foreign application or, to the knowledge of the undersigned, having made reasonable inquiry, was known to any individual designated in 37 CFR §1.56(c) more than three months prior to the filing of this statement.

DEPOSIT ACCOUNT

- ☒ Please charge any additional fees for the papers being filed herewith and for which no check or credit card payment is enclosed herewith, or credit any overpayment to deposit account number 15-0030. A duplicate copy of this sheet is enclosed.

Respectfully submitted,

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Form PTO 1449 (Modified)		U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE		ATTY DOCKET NO. 248168US90CONT		SERIAL NO. NEW APPLICATION	
LIST OF REFERENCES CITED BY APPLICANT				APPLICANT Yasutaka ITO, et al.			
				FILING DATE HEREWITH		GROUP	
U.S. PATENT DOCUMENTS							
EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE
	AA	5,616,024	04/1997	Nobori et al			
	AB	2,409,244	10/1946	Bilan			
	AC	6,080,970	06/2000	Yoshida et al.			
	AD	6,225,606	05/2001	Tsuruta et al.			
	AE	5,331,134	07/1994	Kimura			
	AF	5,294,778	03/1994	Carman et al.			
	AG	4,002,883	01/1977	Hurko			
	AH	4,577,176	03/1986	Bayer, Helmut			
	AI	4,645,911	02/1987	Husslein, Julius			
	AJ	2002/0055021 A1	05/09/2002	Niwa			
	AK	2002/0043530 A1	04/18/2002	Ito			
	AL	2002/0043527 A1	04/18/2002	Ito			
	AM	2003/0015521 A1	01/23/2003	Ito			
	AN	6,507,006 B1	01/14/2003	Hiramatsu et al			
FOREIGN PATENT DOCUMENTS							
		DOCUMENT NUMBER	DATE	COUNTRY	TRANSLATION YES NO		
	AO	11-251040	09/17/1999	JAPAN			
	AP	11-74064	03/16/1999	JAPAN			
	AQ	63-216283	09/08/1988	JAPAN			
	AR	1109423 A1	09/06/1999	EUROPE			
	AS	11074064	03/16/1999	JAPAN			
	AT	55126989	10/01/1980	JAPAN			
	AU	62208586	09/12/1987	JAPAN			
	AV	63-62180	03/18/1988	JAPAN			
OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, etc.)							
	AW	"Thickened-film IC Formation Technique," coordinated by Japan Micro-Electronics Association, published by Industrial Investigation Committee, 1st Ed. published November 25, 1983 and published on December 1, 1983 by Japan Micro-Electronics Association (partial translation)					
	AX						
	AY						
	AZ					<input checked="" type="checkbox"/> Additional References sheet(s) attached	
Examiner					Date Considered		
*Examiner: Initial if reference is considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.							

Form PTO 1449
(Modified)U.S. DEPARTMENT OF COMMERCE
PATENT AND TRADEMARK OFFICE

ATTY DOCKET NO.

248168US90CONT

SERIAL NO.

NEW APPLICATION

LIST OF REFERENCES CITED BY APPLICANT

APPLICANT

Yasutaka ITO, et al.

FILING DATE

HEREWITH

GROUP

U.S. PATENT DOCUMENTS

EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE
	AA	6,465,763	10/15/2002	Ito et al			
	AB	6,475,606	11/05/2002	Niwa			
	AC						
	AD						
	AE						
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	AG						
	AH						
	AI						
	AJ						
	AK						
	AL						
	AM						
	AN						

FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	DATE	COUNTRY	TRANSLATION	
					YES	NO
	AO	63140085	06/11/1988	JAPAN		
	AP	4101380	04/02/1992	JAPAN		
	AQ	11185940	07/09/1999	JAPAN		
	AR					
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	AU					
	AV					

OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, etc.)

	AW	
	AX	
	AY	
	AZ	

☐ Additional References sheet(s) attached

Examiner

Date Considered

*Examiner: Initial if reference is considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

LIST OF RELATED CASES

<u>Docket Number</u>	<u>Serial or Patent Number</u>	<u>Filing or Issue Date</u>	<u>Inventor/ Applicant</u>
246481US90 PCT	09/673,953	12/21/00	ITO, et al.
205232US0 PCT	09/806,477	06/25/01	ITO, et al.
232736US0 CONT	10/346,095	01/17/03	ITO, et al.
242768US90 CONT	10/663,681	09/17/03	ITO, et al.
219421US2 PCT	10/048,490	04/30/02	ITO, et al.
241056US90 CONT	09/524,010	03/13/00	NIWA
241058US90 CONT	09/946,463	09/06/01	NIWA
241064US90 CONT	10/244,008	09/16/02	NIWA
241191US90 CONT	10/670,354	09/26/03	NIWA
223945US0 PCT	10/168,527	06/28/02	HIRAMATSU, et al.
215648US0 PCT	09/926,465	02/12/02	FURUKAWA, et al.
205235US90 PCT	09/831,887	05/23/01	ITO, et al.
234735US90 CONT	10/387,452	03/14/03	ITO, et al.
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*Present Application; listed for information
NFO/wal

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226831US0 CIP	10/226,160	08/23/02	ITO, et al.
242402US90 CONT	10/658,454	09/10/03	ITO, et al.
205295US0 PCT	09/806,478	07/26/01	ITO, et al.
213163US2 PCT	09/926,092	12/27/01	ITO, et al.
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238750US90 CONT	10/618,623	07/15/03	ITO, et al.
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238761US90 CONT	10/618,665	07/15/03	ITO, et al.
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240245US3 CONT	10/619,567	07/16/03	HIRAMATSU, et al.
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*Present Application; listed for information
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